

## T1235H, T1250H

### High temperature 12 A Snubberless™ Triacs

#### **Features**

- Medium current Triac
- 150 °C max. T<sub>i</sub> turn-off commutation
- Low thermal resistance with clip bonding
- Very high 3 quadrant commutation capability
- Packages are RoHS (2002/95/EC) compliant
- UL certified (ref. file E81734)

#### **Applications**

Especially designed to operate in high power density or universal motor applications such as vacuum cleaner and washing machine drum motor, these 12 A Triacs provide a very high switching capability up to junction temperatures of 150 °C.

The heatsink can be reduced, compared to traditional Triacs, according to the high performance at given junction temperatures.

#### **Description**

Available in through-hole or surface mount packages, the T1235H and T1250H Triac series are suitable for general purpose mains power ac switching.

By using an internal ceramic pad, the T12xxH-6l provides voltage insulation (rated at 2500 V rms).

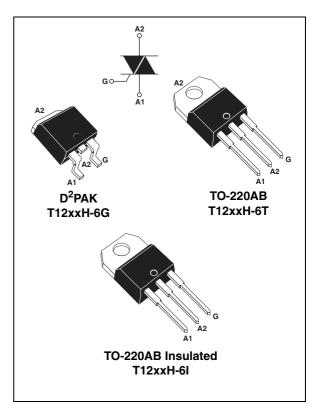


Table 1. Device summary

Symbol	Value	Unit
I <sub>T(RMS)</sub>	12	Α
$V_{DRM}/V_{RRM}$	600	V
I <sub>GT</sub>	35 or 50	mA

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Characteristics T1235H, T1250H

## 1 Characteristics

Table 2. Absolute maximum ratings

Symbol	Parame	Value	Unit			
	On state rms surrent (full sine ways)	D <sup>2</sup> PAK, TO-220AB $T_c = 130  ^{\circ}\text{C}$		12	Α	
I <sub>T(RMS)</sub>	On-state rms current (full sine wave)	TO-220AB Ins	T <sub>c</sub> = 120 °C	12	A	
	Non repetitive surge peak on-state	F = 50 Hz	t = 20 ms 1		^	
I <sub>TSM</sub>	current (full cycle, T <sub>j</sub> initial = 25 °C)	F = 60 Hz	t = 16.7 ms	126	Α	
l <sup>2</sup> t	I <sup>2</sup> t Value for fusing	t <sub>p</sub> = 10 ms		95	A <sup>2</sup> s	
dI/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$ , $t_r \le 100 \text{ ns}$	F = 120 Hz	T <sub>j</sub> = 150 °C	50	A/μs	
V <sub>DSM</sub> /V <sub>RSM</sub>	Non repetitive surge peak off-state voltage	t <sub>p</sub> = 10 ms	T <sub>j</sub> = 25 °C	V <sub>DRM</sub> /V <sub>RRM</sub> + 100	V	
I <sub>GM</sub>	Peak gate current $t_p = 20 \ \mu s$ $T_j = 150 \ ^{\circ}C$		4	Α		
$P_{G(AV)}$	Average gate power dissipation $T_j = 150 ^{\circ}\text{C}$			1	W	
T <sub>stg</sub> T <sub>j</sub>	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 150	°C	

Table 3. Electrical characteristics ( $T_j = 25$  °C, unless otherwise specified)

Cymbol	Test conditions	Quadrant		Value		Unit
Symbol	rest conditions			T1235H T1250H	Ollit	
I <sub>GT</sub> <sup>(1)</sup>	$V_{\rm D} = 12 \text{ V, R}_{\rm I} = 33 \Omega$	1 - 11 - 111	MAX.	35	50	mA
$V_{GT}$	VD = 12 V, 11[ = 00 32	1 - 11 - 111	MAX.	1.0		V
$V_{GD}$	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega$ I - II - III		MIN.	0.15		V
I <sub>H</sub> <sup>(2)</sup>	I <sub>T</sub> = 500 mA		MAX.	35	75	mA
	I <sub>G</sub> = 1.2 I <sub>GT</sub>	I - III	MAX.	50	90	mA
IL	IG = 1.2 IGT	II		80	110	IIIA
dV/dt (2)	V <sub>D</sub> = 67% V <sub>DRM,</sub> gate open, T <sub>j</sub> = 150 °C		MIN.	1000	1500	V/µs
(dl/dt)c (2)	Without snubber, T <sub>j</sub> = 150 °C		MIN.	16	21	A/ms

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<sup>1.</sup> minimum  $I_{\mbox{\footnotesize GT}}$  is guaranted at 20% of  $I_{\mbox{\footnotesize GT}}$  max.

<sup>2.</sup> for both polarities of A2 referenced to A1.

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Table 4. Static characteristics

Symbol	Test conditions			Value	Unit
V <sub>T</sub> <sup>(1)</sup>	I <sub>TM</sub> = 17 A, t <sub>p</sub> = 380 μs	T <sub>j</sub> = 25 °C	MAX.	1.5	V
V <sub>t0</sub> <sup>(1)</sup>	Threshold voltage	T <sub>j</sub> = 150 °C	MAX.	0.80	V
R <sub>d</sub> <sup>(1)</sup>	Dynamic resistance	T <sub>j</sub> = 150 °C	MAX.	30	mΩ
	$V_{DRM} = V_{BRM}$	T <sub>j</sub> = 25 °C	MAX.	5	μA
I <sub>DRM</sub>	VDRM = VRRM	T <sub>j</sub> = 150 °C	MAX.	3.9	
I <sub>RRM</sub> <sup>(2)</sup>	V <sub>D</sub> /V <sub>R</sub> = 400 V (at peak mains voltage)	T <sub>j</sub> = 150 °C	MAX.	3.2	mA
	V <sub>D</sub> /V <sub>R</sub> = 200 V (at peak mains voltage)	T <sub>j</sub> = 150 °C	MAX.	2.7	

<sup>1.</sup> for both polarities of A2 referenced to A1

Table 5. Thermal resistance

Symbol	Parameter			Value	Unit
В	lunation to soon (AC)		D <sup>2</sup> PAK / TO-220AB	1.4	
R <sub>th(j-c)</sub>	Junction to case (AC)		TO-220AB Ins	3.3	0000
R <sub>th(j-a)</sub> Junction to ambient	lunation to ombiont	$S = 1 \text{ cm}^2$	D <sup>2</sup> PAK	45	°C/W
	Junction to ambient		TO-220AB / TO-220AB Ins	60	-

<sup>2.</sup>  $t_p = 380 \mu s$ 

Characteristics T1235H, T1250H

Figure 1. Maximum power dissipation versus Figure 2. On-state rms current versus case on-state rms current (full cycle) temperature (full cycle)

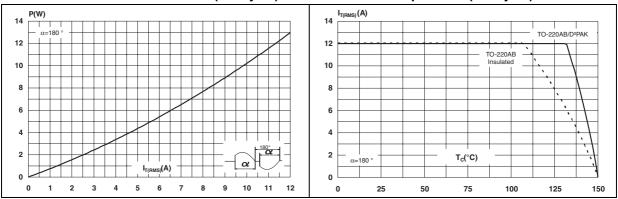


Figure 3. On-state rms current versus ambient temperature

Figure 4. Variation of thermal impedance versus pulse duration

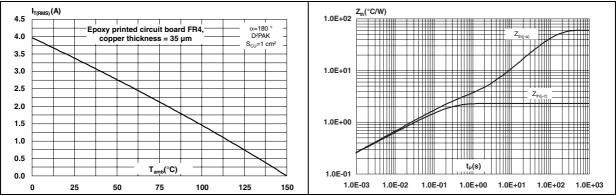
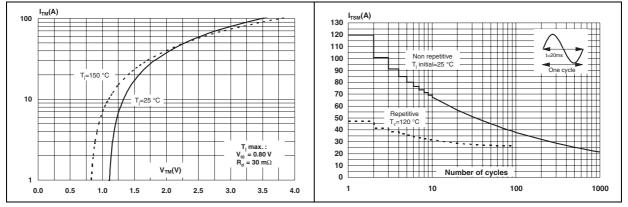


Figure 5. On-state characteristics (maximum values)

Figure 6. Surge peak on-state current versus number of cycles



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Figure 7. Non-repetitive surge peak on-state Figure 8. Relative variation of  $I_{GT}$ ,  $I_{L}$  vs current for a sinusoidal pulse with junction temperature (typical values)

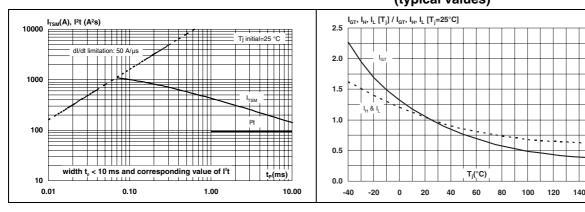


Figure 9. Relative variation of critical rate of Figure 10. decrease of main current (dl/dt)c versus reapplied (dV/dt)c

Figure 10. Relative variation of critical rate of decrease of main current versus junction temperature

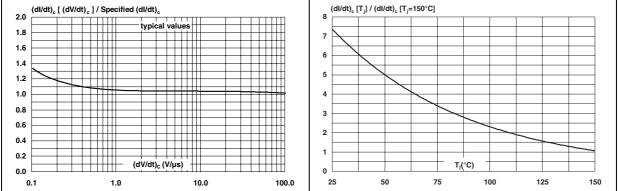
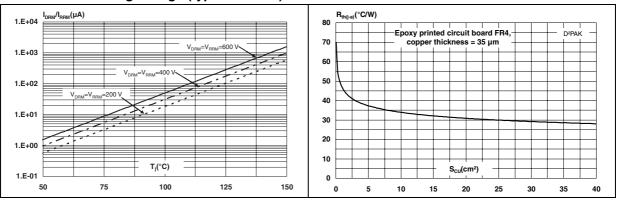


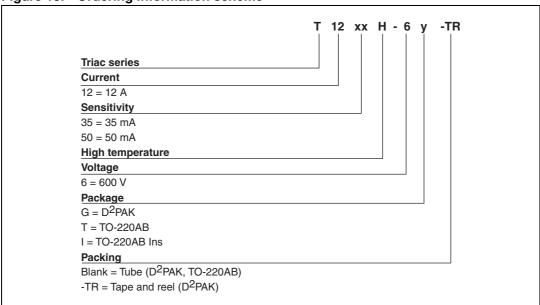
Figure 11. Leakage current versus junction temperature for different values of blocking voltage (typical values)

Figure 12. Variation of thermal resistance junction to ambient versus copper surface under tab



## 2 Ordering information scheme

Figure 13. Ordering information scheme



T1235H, T1250H Package information

#### 3 Package information

- Epoxy meets UL94, V0
- Recommended torque 0.4 to 0.6 N⋅m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

Table 6. D<sup>2</sup>PAK dimensions

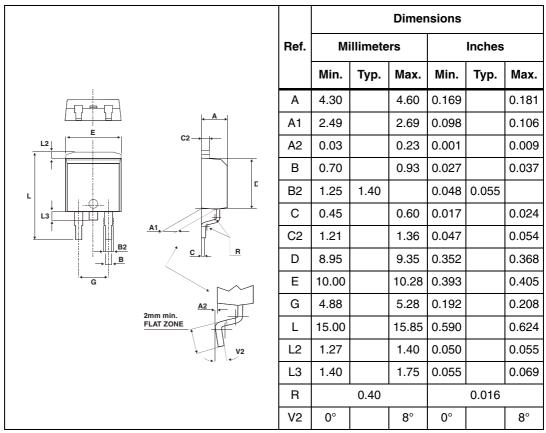
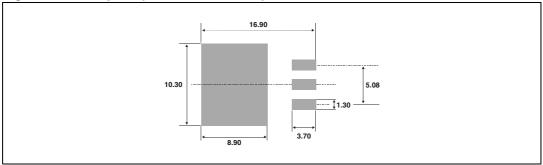


Figure 14. Footprint (dimensions in mm)



Package information T1235H, T1250H

**Dimensions** Ref. Millimeters Inches Min. Typ. Max. Min. Тур. Max. 15.20 15.90 0.598 0.625 Α 0.147 a1 3.75 В a2 13.00 14.00 0.511 0.551 Ø١ В 10.00 10.40 0.393 0.409 b1 0.61 0.88 0.024 0.034 0.051 b2 1.23 1.32 0.048 14 С 4.40 4.60 0.173 0.181 13 с1 0.49 0.70 0.019 0.027 c2 c2 2.40 2.72 0.094 0.107 a2 2.40 2.70 0.094 0.106 е F 6.20 6.60 0.244 0.259 ØΙ 3.75 3.85 0.147 0.151 0.661 14 15.80 16.40 16.80 0.622 0.646 L 2.65 2.95 0.104 0.116 12 1.14 0.044 0.066 1.70 13 1.14 1.70 0.044 0.066 Μ 2.60 0.102

Table 7. TO-220AB and TO-220AB Ins dimensions

# 4 Ordering information

 Table 8.
 Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
T12xxH-6G	T12xxH 6G	D <sup>2</sup> PAK	1.5 g	50	Tube
T12xxH-6G-TR	T12xxH 6G	D <sup>2</sup> PAK	1.5 g	1000	Tape and reel
T12xxH-6T	T12xxH 6T	TO-220AB	2.3 g	50	Tube
T12xxH-6l	T12xxH 6l	TO-220AB Ins	2.3 g	50	Tube

## 5 Revision history

Table 9. Document revision history

Date	Revision	Changes	
17-Apr-2007	1	First issue.	
20-Sep-2011	2	Updated: Features, Description and Figure 2.	

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